

- Ideal Front-End Filter for Domestic Wireless Receivers
- Low-Loss, Coupled-Resonator Quartz Design
- Simple External Impedance Matching
- Surface-Mount Ceramic Case with 52 mm² Footprint
- Complies with Directive 2002/95/EC (RoHS)

The RF1211B is a low-loss, compact, and economical surface-acoustic-wave (SAW) filter designed to provide front-end selectivity in 315.0 MHz receivers. Receiver designs using this filter include superhet with 10.7 MHz or 500 kHz IF, direct conversion and superregen. Typical applications of these receivers are wireless remote-control and security devices (especially for automotive keyless entry) operating in the USA under FCC Part 15, in Canada under RSS-210, and in Italy

This coupled-resonator filter (CRF) uses selective null placement to provide suppression, typically greater than 40 dB, of the LO and image spurious responses of superhet receivers with 10.7 MHz IF. RFM's advanced SAW design and fabrication technology is utilized to achieve high performance and very low loss with simple external impedance matching (not included). Our new patent pending solder seal process utilizes a Faraday shield lid, which improves out of band rejection.

RF1211B

315.0 MHz SAW Filter



SM8558-8 Case

Electrical Characteristics

	Characteristic	Sym	Notes	Minimum	Typical	Maximum	Units
Nominal Frequency		f _c	1, 2		315.00		MHz
	Tolerance from 315.0 MHz	Δfc	1, 2			±80	dB
Insertion Loss		IL	1		1.7	3.0	dB
3 dB Bandwidth		BW ₃	1, 2	500	700	800	kHz
Rejection	at f _c - 21.4 MHz (Image)			40	50		
	at f _c - 10.7 MHz (LO)		1	15	40		
	Ultimate				80		dB
Temperature	Operating Case Temp.	T _C		-40		+85	°C
	Turnover Temperature	T _O	3, 4	22	37	52	°C
	Turnover Frequency	f _O			f _c		MHz
	Freq. Temp. Coefficient	FTC			0.032		ppm/°C ²
Frequency Aging	Absolute Value during the First Year	fA	5		≤10		ppm/yr
External Impedance	Series Inductance	L	1	86 nH (Pin 1), 82 nH (Pin 2)			
	Shunt Capacitance	С	'		9		pF
Lid Symbolization (in addition to Lot and/or Date Codes)		RFM RF1211B					



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

Notes:

- Unless noted otherwise, all measurements are made with the filter installed in the specified test fixture which is connected to a 50 Ω test system with VSWR ≤ 1.2:1. The test fixture L and C are adjusted for minimum insertion loss at the filter center frequency, f_c. Note that insertion loss, bandwidth, and passband shape are dependent on the impedance matching component values and quality.
- 2. The frequency f_c is defined as the midpoint between the 3dB frequencies.
- 3. Unless noted otherwise, specifications apply over the entire specified operating temperature range.
- 4. The turnover temperature, T_O , is the temperature of maximum (or turnover) frequency, f_O . The nominal frequency at any case temperature, T_C , may be calculated from: $f = f_O [1 FTC (T_O T_C)^2]$.
- 5. Frequency aging is the change in fc with time and is specified at +65°C or less. Aging may exceed the specification for prolonged temperatures above +65°C. Typically, aging is greatest the first year after manufacture, decreasing significantly in subsequent years.
- 6. The design, manufacturing process, and specifications of this device are subject to change without notice.
- One or more of the following U.S. Patents apply: 4,54,488, 4,616,197, and others pending.
- 8. All equipment designs utilizing this product must be approved by the appropriate government agency prior to manufacture or sale.

Absolute Maximum Ratings

	Value	Units	
Incident RF Power	+13	dBm	
DC Voltage between any 2 pins (Ol	±30	VDC	
Case Temperature ⁵		-40 to +85	°C
Soldering Temperature	(10 seconds / 5 cycles max.)	260	°C

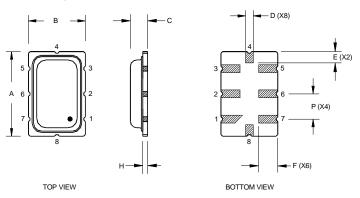
Typical Filter Response

Typical filter responses are shown below. The actual response is dependent on external impedance matching and circuit layout. Illustrated frequencies and minimum rejection for LO and IMAGE are shown only for superhet receivers with 10.7 MHz IF.

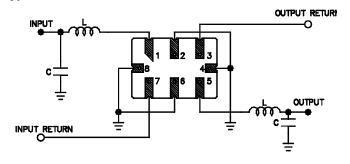
Electrical Connections

Pin	Connection
1	Input
2	Ground
3	Output Return
4	Case Ground
5	Output
6	Ground
7	Input Return
8	Case Ground

Case Design



Typical Test Circuit



Case Dimensions

Dimension	mm			Inches			
	Min	Nom	Max	Min	Nom	Max	
Α	8.26	8.51	8.76	0.325	0.335	0.345	
В	5.59	5.84	6.10	0.220	0.230	0.240	
С		1.70	2.00		0.067	0.079	
D		0.79			0.031		
E		1.14			0.045		
F		1.98			0.078		
Н		0.51			0.020		
Р		2.54			0.100		

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